## IRF730B



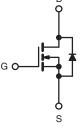
**Vishay Siliconix** 

## **D** Series Power MOSFET

| PRODUCT SUMMARY                       |                 |     |  |  |
|---------------------------------------|-----------------|-----|--|--|
| $V_{DS}$ (V) at $T_J$ max.            | 450             |     |  |  |
| R <sub>DS(on)</sub> max. at 25 °C (Ω) | $V_{GS} = 10 V$ | 1.0 |  |  |
| Q <sub>g</sub> max. (nC)              | 18              |     |  |  |
| Q <sub>gs</sub> (nC)                  | 3               |     |  |  |
| Q <sub>gd</sub> (nC)                  | 4               |     |  |  |
| Configuration                         | Single          |     |  |  |

## TO-220AB





N-Channel MOSFET

### FEATURES

- Optimal Design
  - Low Area Specific On-Resistance
  - Low Input Capacitance (Ciss)
  - Reduced Capacitive Switching Losses
  - High Body Diode Ruggedness
  - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
  - Low Cost
  - Simple Gate Drive Circuitry
  - Low Figure-of-Merit (FOM): Ron x Qa
  - Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

### **APPLICATIONS**

- Consumer Electronics
- Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies

   SMPS
- Industrial
  - Welding
  - weiding
  - Induction Heating
- Motor Drives
- Battery Chargers

| ORDERING INFORMATION |            |
|----------------------|------------|
| Package              | TO-220AB   |
| Lead (Pb)-free       | IRF730BPbF |

| ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :       | = 25 °C, unless otherwis                | se noted)                         |                  |      |  |
|--|---|-----------------------------------|------------------|------|--|
| PARAMETER  |   | SYMBOL                            | LIMIT            | UNIT |  |
| Drain-Source Voltage                             | V <sub>DS</sub>                         | 400                               |                  |      |  |
| Gate-Source Voltage                              |   | V <sub>GS</sub>                   | ± 30             | V    |  |
| Gate-Source Voltage AC (f > 1 Hz)                | 30                                      |                                   |                  |      |  |
| Continuous Drain Current (T, = 150 °C)           | $V_{GS}$ at 10 V $T_C = 25 \degree C$   | I <sub>D</sub>                    | 6                |      |  |
| Continuous Drain Current (1j = 150°C)            | $V_{GS}$ at 10 V $T_C = 100 \text{ °C}$ |                                   | 4                | А    |  |
| Pulsed Drain Current <sup>a</sup>                |   | I <sub>DM</sub>                   | 13               |      |  |
| Linear Derating Factor                           |   |                                   | 0.8              | W/°C |  |
| Single Pulse Avalanche Energy <sup>b</sup>       |   | E <sub>AS</sub>                   | 104              | mJ   |  |
| Maximum Power Dissipation                        |   | PD                                | 104              | W    |  |
| Operating Junction and Storage Temperature Range |   | T <sub>J</sub> , T <sub>stg</sub> | - 55 to + 150    | °C   |  |
| Drain-Source Voltage Slope                       | T <sub>J</sub> = 125 °C                 | 25 °C dV/dt 24                    |                  | V/ns |  |
| Reverse Diode dV/dt <sup>d</sup>                 |   | uv/ul                             | 0.48             |      |  |
| Soldering Recommendations (Peak Temperature)     | for 10 s                                |                                   | 300 <sup>c</sup> | °C   |  |

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 2.3 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 9.5 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D,$  starting  $T_J$  = 25 °C.

S12-1392-Rev. A, 18-Jun-12

COMPLIANT

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| PARAMETER   | SYMBOL              | TYP.  |  | MAX.                  |      | UNIT |       |      |
|---|---------------------|---|--|-----------------------|------|------|-------|------|
| Maximum Junction-to-Ambient                                 | R <sub>thJA</sub>   | -   |  | 62                    |      |      |       |      |
| Maximum Junction-to-Case (Drain)                            | R <sub>thJC</sub>   | - 1.2   |  |                       | °C/W |      |       |      |
|   |                     |   |  |                       |      |      |       |      |
| <b>SPECIFICATIONS</b> (T <sub>.1</sub> = 25 $^{\circ}$ C, u | Inless otherwi      | se noted)   |  |                       |      |      |       |      |
| PARAMETER   | SYMBOL              | ,   | T CONDITION  | S                     | MIN. | TYP. | MAX.  | UNIT |
| Static  |                     |   |  |                       | I    |      |       |      |
| Drain-Source Breakdown Voltage                              | V <sub>DS</sub>     | V <sub>GS</sub> =   | = 0 V, I <sub>D</sub> = 250  | μA                    | 400  | -    | -     | V    |
| V <sub>DS</sub> Temperature Coefficient                     | $\Delta V_{DS}/T_J$ |   | to 25 °C, I <sub>D</sub> =   |                       | -    | 0.53 | -     | V/°C |
| Gate-Source Threshold Voltage (N)                           | V <sub>GS(th)</sub> | V <sub>DS</sub> =   | = V <sub>GS</sub> , I <sub>D</sub> = 250   | μA                    | 3    | -    | 5     | V    |
| Gate-Source Leakage   | I <sub>GSS</sub>    | -   | $V_{GS} = \pm 30 \text{ V}$  | •                     | -    | -    | ± 100 | nA   |
|   |                     |   | = 400 V, V <sub>GS</sub> =   | 0 V                   | -    | -    | 1     |      |
| Zero Gate Voltage Drain Current                             | I <sub>DSS</sub>    |   | $V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$<br>$V_{DS} = 320 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$ |                       | -    | -    | 10    | μA   |
| Drain-Source On-State Resistance                            | R <sub>DS(on)</sub> | $V_{GS} = 10 V$ $I_D = 3 A$   |  | -                     | 0.85 | 1.0  | Ω     |      |
| Forward Transconductance                                    | 9 <sub>fs</sub>     | V <sub>DS</sub> = 50 V, I <sub>D</sub> = 3 A  |  | -                     | 1.7  | -    | S     |      |
| Dynamic   |                     |   |  |                       | •    | •    |       |      |
| Input Capacitance   | C <sub>iss</sub>    | V <sub>GS</sub> = 0 V,  |  |                       | -    | 311  | -     | pF   |
| Output Capacitance  | C <sub>oss</sub>    | $V_{DS} = 0.0$ V,<br>$V_{DS} = 100$ V,<br>f = 1 MHz   |  | -                     | 38   | -    |       |      |
| Reverse Transfer Capacitance                                | C <sub>rss</sub>    |   |  | -                     | 7    | -    |       |      |
| Effective output capacitance, energy related <sup>a</sup>   | C <sub>o(er)</sub>  | V <sub>GS</sub> = 0 V,<br>V <sub>DS</sub> = 0 V to 320 V  |  | -                     | 44   | -    |       |      |
| Effective output capacitance, time related <sup>b</sup>     | C <sub>o(tr)</sub>  |   |  | -                     | 54   | -    |       |      |
| Total Gate Charge   | Qg                  |   |  |                       | -    | 9    | 18    | nC   |
| Gate-Source Charge  | Q <sub>gs</sub>     | $V_{GS} = 10 \text{ V}$   | I <sub>D</sub> = 3 A, V  | <sub>DS</sub> = 320 V | -    | 3    | -     |      |
| Gate-Drain Charge   | Q <sub>gd</sub>     |   |  |                       | -    | 4    | -     | 1    |
| Turn-On Delay Time  | t <sub>d(on)</sub>  |   |  |                       | -    | 12   | 24    |      |
| Rise Time   | t <sub>r</sub>      | $\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 400 \; \text{V}, \; I_{\text{D}} = 3 \; \text{A}, \\ V_{\text{GS}} = 10 \; \text{V}, \; R_{g} = 9.1 \; \Omega \end{array}$ |  | -                     | 11   | 22   | ns    |      |
| Turn-Off Delay Time   | t <sub>d(off)</sub> |   |  | -                     | 14   | 28   |       |      |
| Fall Time   | t <sub>f</sub>      |   |  | -                     | 8    | 16   |       |      |
| Gate Input Resistance                                       | R <sub>g</sub>      | f = 1 MHz, open drain   |  | -                     | 1.9  | -    | Ω     |      |
| Drain-Source Body Diode Characteristi                       |                     |   |  |                       |      |      |       |      |
| Continuous Source-Drain Diode Current                       | I <sub>S</sub>      | MOSFET symbol<br>showing the<br>integral reverse<br>p - n junction diode  |  | -                     | -    | 6    | А     |      |
| Pulsed Diode Forward Current                                | I <sub>SM</sub>     |   |  | -                     | -    | 24   |       |      |
| Diode Forward Voltage                                       | V <sub>SD</sub>     | T <sub>J</sub> = 25 °   | C, I <sub>S</sub> = 3 A, V <sub>G</sub>  | <sub>S</sub> = 0 V    | -    | -    | 1.2   | V    |
| Reverse Recovery Time                                       | t <sub>rr</sub>     |   |  |                       | -    | 236  | -     | ns   |
| Reverse Recovery Charge                                     | Q <sub>rr</sub>     | $T_J = 25 \text{ °C}, I_F = I_S = 3 \text{ A},$   |  | -                     | 1.1  | -    | μC    |      |
| Reverse Recovery Current                                    | I <sub>RRM</sub>    | ui/ut =   | dl/dt = 100 A/µs, V <sub>R</sub> = 20 V  |                       | -    | 9    | -     | A    |

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

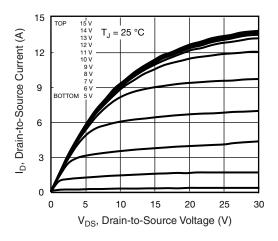


Fig. 1 - Typical Output Characteristics

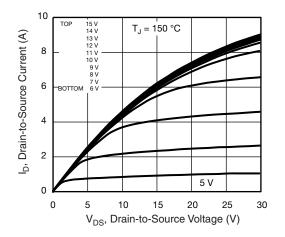


Fig. 2 - Typical Output Characteristics

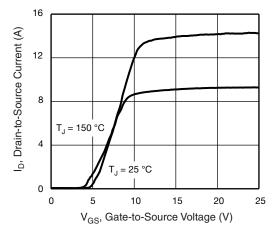


Fig. 3 - Typical Transfer Characteristics

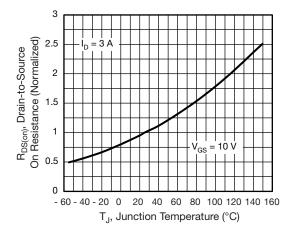


Fig. 4 - Normalized On-Resistance vs. Temperature

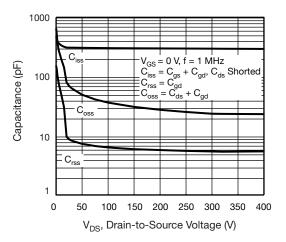


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

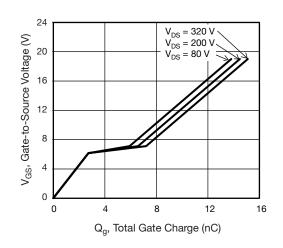
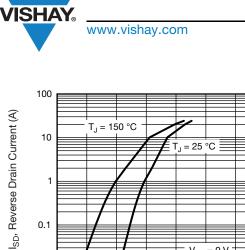


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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**IRF730B** 

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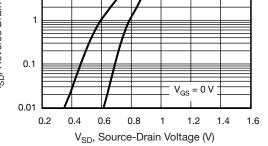


Fig. 7 - Typical Source-Drain Diode Forward Voltage

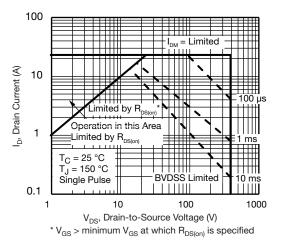


Fig. 8 - Maximum Safe Operating Area

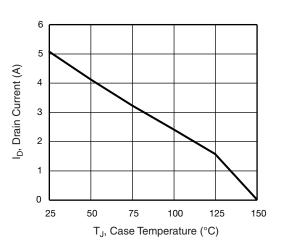


Fig. 9 - Maximum Drain Current vs. Case Temperature

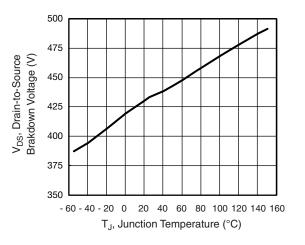


Fig. 10 - Temperature vs. Drain-to-Source Voltage

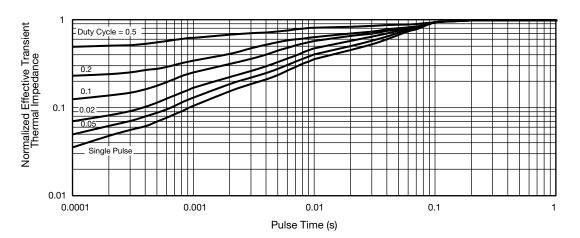
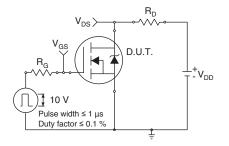


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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Fig. 12 - Switching Time Test Circuit

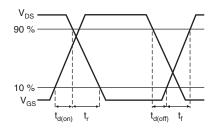


Fig. 13 - Switching Time Waveforms

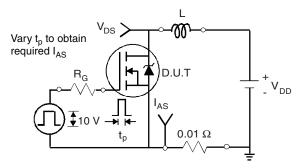


Fig. 14 - Unclamped Inductive Test Circuit

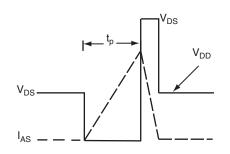


Fig. 15 - Unclamped Inductive Waveforms

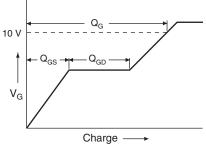


Fig. 16 - Basic Gate Charge Waveform

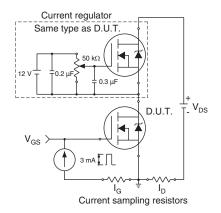


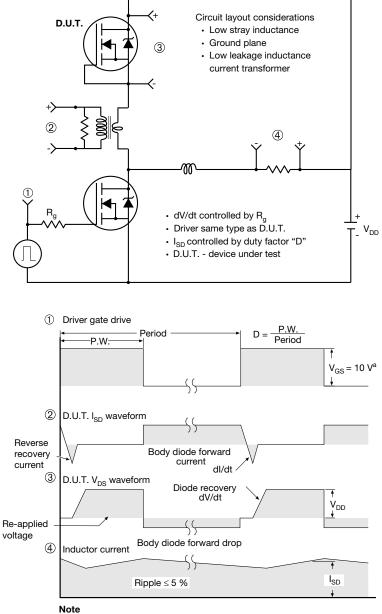
Fig. 17 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 18 - For N-Channel

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TO-220-1



| DIM  | MILLIN | METERS | INCHES | HES   |
|------|--------|--------|--------|-------|
| DIM. | MIN.   | MAX.   | MIN.   | MAX.  |
| А    | 4.24   | 4.65   | 0.167  | 0.183 |
| b    | 0.69   | 1.02   | 0.027  | 0.040 |
| b(1) | 1.14   | 1.78   | 0.045  | 0.070 |
| С    | 0.36   | 0.61   | 0.014  | 0.024 |
| D    | 14.33  | 15.85  | 0.564  | 0.624 |
| E    | 9.96   | 10.52  | 0.392  | 0.414 |
| е    | 2.41   | 2.67   | 0.095  | 0.105 |
| e(1) | 4.88   | 5.28   | 0.192  | 0.208 |
| F    | 1.14   | 1.40   | 0.045  | 0.055 |
| H(1) | 6.10   | 6.71   | 0.240  | 0.264 |
| J(1) | 2.41   | 2.92   | 0.095  | 0.115 |
| L    | 13.36  | 14.40  | 0.526  | 0.567 |
| L(1) | 3.33   | 4.04   | 0.131  | 0.159 |
| ØP   | 3.53   | 3.94   | 0.139  | 0.155 |
| Q    | 2.54   | 3.00   | 0.100  | 0.118 |

### Note

• M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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